

CRMNTL10120A

N-Channel 100V, 92mΩ Typ. Power MOSFET

Description

Features

• 100V, 3A

 $R_{DS(ON)}$ Typ = 92m Ω @ V_{GS} = 10V

 $R_{DS(ON)}$ Typ = 98m Ω @ V_{GS} = 4.5V

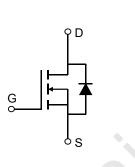
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free

Application

PWM Application

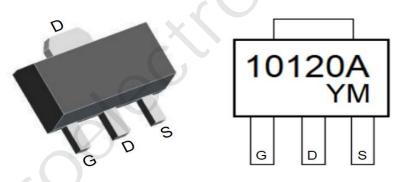
• Power Management

· Load Switch





Schematic Diagram



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMNTL10120A	10120A	SOT-89-3L	TAPING	7"	1000	40000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _A = 25°C	3	А
I _D	Continuous Drain Current	T _A = 100°C	1.8	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		12	А
P _D	Power Dissipation	T _A = 25°C	2.23	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient ⁽²⁾		56	°C/W
T _J , T _{stg}	Junction & Storage Temperature Rang	је	-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, $V_{\rm GS}$ = 0V	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1	1.5	2.5	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 3A	-	92	120	mΩ
		V _{GS} = 4.5V, I _D = 2A	-	98	127	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	850	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	Χ-	43	-	pF
C _{rss}	Reverse Transfer Capacitance			35	-	pF
Q _g	Total Gate Charge	0	<u> </u>	18.5	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 50V$, $I_{D} = 2A$	-	2.9	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$, $i_{\rm D} = 2A$	-	4.2	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	5.94	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 50V	-	6.44	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 2A, R_{GEN} = 3 Ω	-	20.62	-	ns
t _f	Turn-Off Fall Time		-	2.78	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	3	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	12	А
V_{SD}	Drain to Source Diode Forward Voltage $V_{GS} = 0V$, $I_S = 3A$		-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	25	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 3A, di/dt = 100A/us	_	30	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

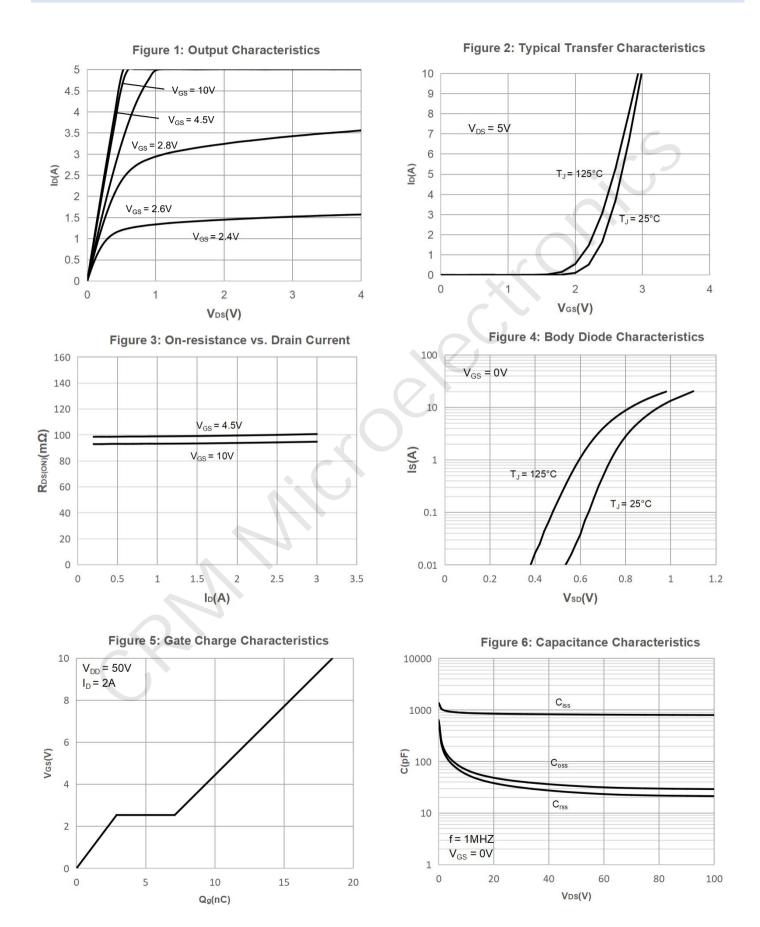
2. $R_{\rm 6JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.



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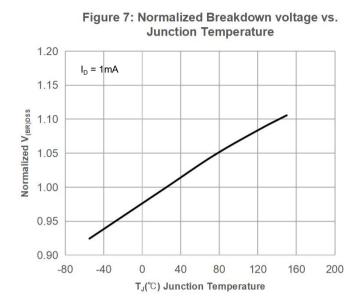
Typical Performance Characteristics



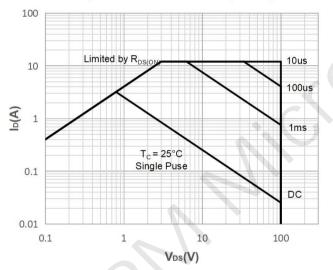


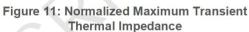
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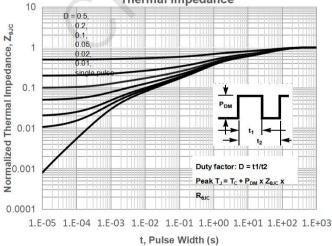
Typical Performance Characteristics











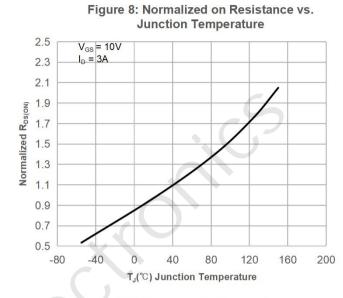


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

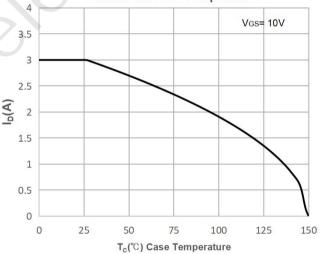
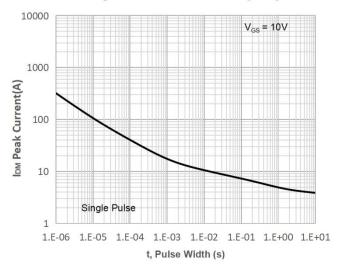


Figure 12: Peak Current Capacity

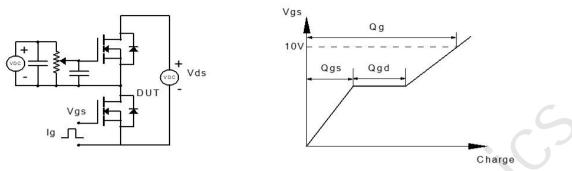




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Test Circuit





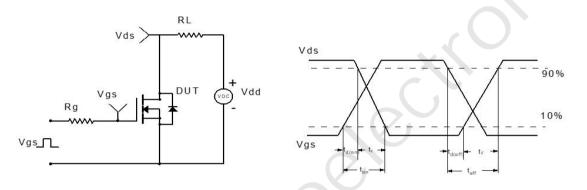


Figure 2: Resistive Switching Test Circuit & Waveform

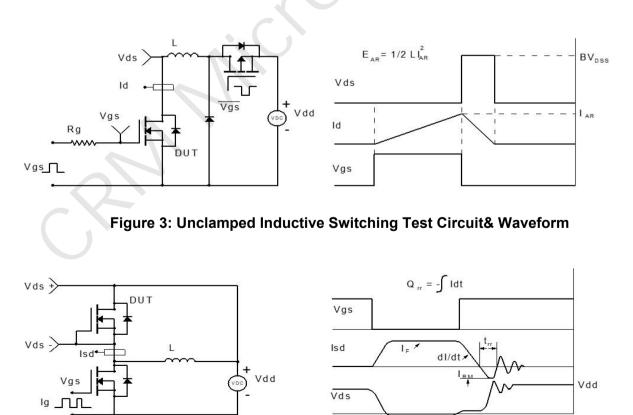
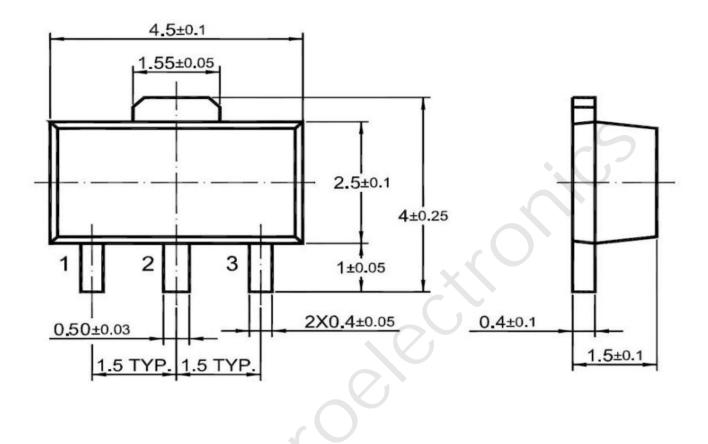


Figure 4: Diode Recovery Test Circuit & Waveform



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Package Mechanical Data(SOT-89-3L)



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